

SPECIFICATION

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SPEC. NO.: PS-50911-XXXXX-XXX REVISION: A

PRODUCT NAME: SAS CONNECTOR RCPT S/T HYBRID TYPE

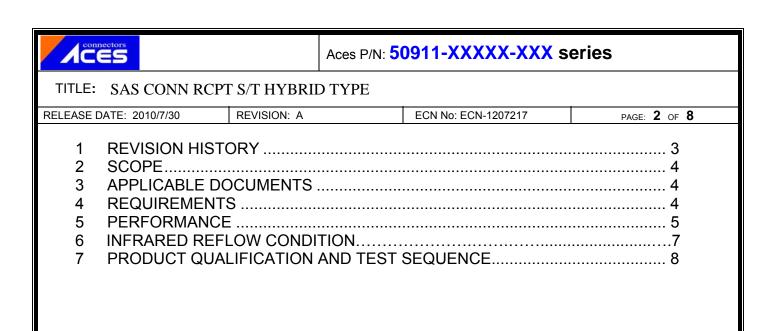
PRODUCT NO: 50911; 51890 SERIES

PREPARED: CHECKED: APPROVED:

XIAOXIONG CARL JASON

DATE: DATE:

2010/7/30 2010/7/30 2010/7/30



Aconnectors CES	Aces P/N: 50911-XXXXXX-XXX series
TITLE: SAS CONN PCPT S/T HVRPH	TVPF

IIILE: SAS CONN RCPT S/T HYBRID TYPE

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1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
0	ECN-1003132	RELEASE	JASON	2010/3/30
Α	ECN-1207217	ADD 51890 SERIES	XIAOXIONG	2012/7/30
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2 SCOPE

This specification covers performance, tests and quality requirements for SAS connector. Refer to ACES P/N: 50911; 51890 series

3 APPLICABLE DOCUMENTS

EIA-364:ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

- 4.1 Design and Construction
 - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
 - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
 - 4.2.1 Contact: High performance copper alloy

Plated: (a) Finish: See Order Information.

(b) Under plate: Nickel-plated all over.

- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Fitting nail: High performance copper alloy

Plated: (a) Finish: See Order Information.

(b) Under plate: Nickel-plated all over.

4.3 Ratings

4.3.1 Voltage: 30 Volts DC

4.3.2 Current: 1.5 Amperes per pin

4.3.3 Operating Temperature : 0°C to +55°C

Non-Operating Temperature : -40°C to +85°C



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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard					
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.					
ELECTRICAL							
Item	Requirement	Standard					
Low-signal Level Contact Resistance	30 m Ω Max.(initial)per contact 15 m Ω Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)					
Insulation Resistance	1000 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)					
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 0.5 m A max.	500 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)					
Temperature rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current after:1.5 A/Power contact. The temperature rise above ambient shall not exceed 30°C The ambient condition is still air at 25°C (EIA-364-70 METHOD 2)					
	MECHANICAL						
Durability	500 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 10 ± 3 mm/min, (200 cycles per hour max.) (EIA-364-09)					
Mating / Un-mating Forces	Mating Force: 25N (2.55kgf) Max. Un-mating Force: 5N (0.5kgf) Min.	Operation Speed: 25.4 ± 3 mm/minute Measure the force required to mate/Un-mate connector. (EIA-364-13)					
Terminal / Housing Retention Force	1.96N(0.2kgf) Min.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing.					
Fitting nail / Housing Retention Force	1.96N(0.2kgf) Min.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the fitting nail assembled in the housing.					
Vibration	1 μ s Max.	The electrical load condition shall					



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		contacts. Sub harmonic moti of 0.76mm (1. total excursion between the li The entire fred 10 to 55 Hz ar shall be traver 1 minute. This applied for 2 h	paximum for all bject to a simple ion having amplitude 52mm maximum in in frequency mits of 10 and 55 Hz. quency range, from ind return to 10 Hz, resed in approximately is motion shall be nours in each of three endicular directions.			
Shock (Mechanical)	1 μs Max.	G's (peak va pulses of 11 r Three shocks shall be appl mutually perportest speciment electrical load 100mA maxim	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition H)			
	ENVIRON	MENTAL				
Hand Solder Ability	See Product Qualificat Sequence Group 6	tion and Test Soldering iron Duration:3~4s				
Thermal Shock	See Product Qualificat Sequence Group 3	condition for 1 tion and Test 1 cycles: -55 +0/-3 °C, 3 +85 +3/-0 °C,	30 minutes			
Humidity	See Product Qualificat Sequence Group 3	Mated Connettion and Test 40°C, 90~95° Reefer to Metl (EIA-364-31, 7	% RH, 96Hour.			
Temperature life	See Product Qualificat Sequence Group 4	Subject mated tion and Test temperature lithours. Measur	d connectors to fe at 85°C for 500			
Salt Spray	See Product Qualificat Sequence Group 5	Subject mated connectors to concentration,	d/unmated			
Solder ability	Solder able area shall minimum of 95% solde	have And then into				

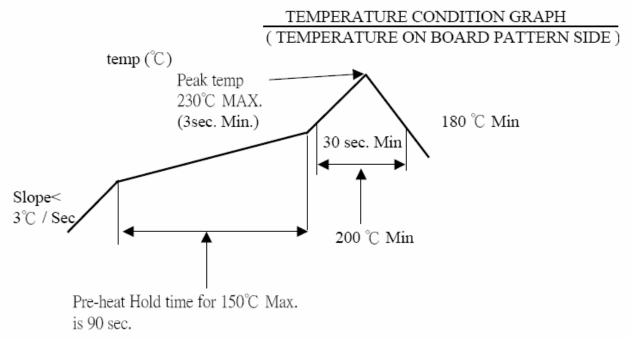


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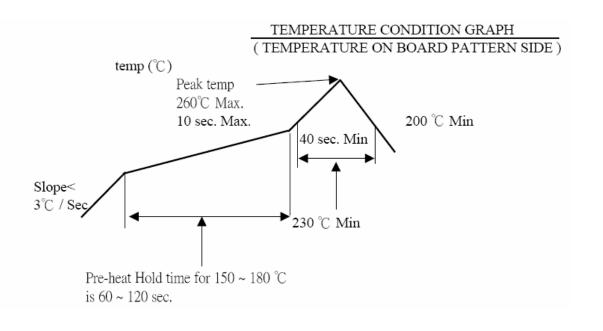
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6 INFRARED REFLOW CONDITION

6.1. General Process



6.2. Lead-free Process



connectors					
CES					

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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9	10
	Test Sequence									
Examination of Product	1 . 7	1 . 6	1 . 7	1、6	1 \ 4			1 . 3	1、3	
Low-signal Level Contact Resistance	2 ` 6	2 \ 5	2、10	2、9	2 \ 5					
Insulation Resistance			3 . 9	3 · 8						
Dielectric Withstanding Voltage			4 \ 8	4 · 7						
Mating / Unmating Forces	3 \ 5									
Temperature rise									2	
Durability	4									
Contact Retention Force							1			
Vibration(Random) / Vibration		3								
Shock (Mechanical)		4								
Thermal Shock			5							
Humidity			6							
Temperature life				5						
Salt Spray					3					
Solder ability						1				
Resistance to Soldering Heat								2		
Sample Size	4	4	4	4	4	2	4	4	2	